# **High Density**

## 17 BH/HD SERIES

#### SPECIFICATIONS:

#### **MATERIALS AND PLATINGS**

Shells Steel, tin plated,

grounding indents on plug.

**Contact Material** Copper alloy **Contact Plating** 

Engagement area: gold (see ordering information).

Termination End 150µ" (3.81µm) tin/lead Nickel Underplate 50μ" (1.27μm) entire contact

#### **ELECTRICAL DATA**

**Current Rating** 3 Amps maximum per contact

Voltage Rating 125 VAC

Dielectric Withstanding Voltage 1000 VAC (minimum)

Dielectric

Glass filled thermoplastic,

black, UL 94 VO 5,000 Megaohms (minimum) **Insulation Resistance** 15 Milliohms (maximum)

**Contact Resistance** 

#### **CLIMATIC DATA**

-67°F (-55°C) to 221°F (105°C) **Operating Temperature** 



Amphenol's High Density **D-Subminiature connectors** compleme nt Amphenol's extensive D-Subminiature connector line. This line of connectors offers many superior features, high performance level and low installation cost.

The connector configurations are available in 15, 26, 44, 62 and 78 positions.

The product offering includes PCB mount connectors in both straight or right angle termination styles. Straight PCB mount are available in both Fixed Screw Machine and Stamped and Formed contacts, while Right Angle PCB mount are only available with Stamped and Formed contacts.

A cable mount version with solder terminations is also available, which can be combined with Amphenol's standard line of shielded or unshielded backshells.

- Industrial
- Telecom
- Any industry standard I / O connections

INCHES (MM)

2

### 17HD SERIES



